

Philips

Diode BYD43-16

Datasheet

# Silicon Diode

## **BYD43-16**

1600V/680mA

# DATASHEET

OEM – Philips

Source: Philips Databook 1999

**Fast soft-recovery rectifiers****BYD43 series****FEATURES**

- Glass passivated
- High maximum operating temperature
- Low leakage current
- Excellent stability
- Available in ammo-pack.

**DESCRIPTION**

Cavity free cylindrical glass package through Implotec™<sup>(1)</sup> technology.  
This package is hermetically sealed

and fatigue free as coefficients of expansion of all used parts are matched.

(1) Implotec is a trademark of Philips.

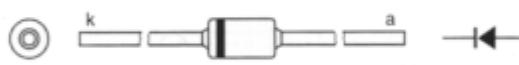


Fig.1 Simplified outline (SOD81) and symbol.

**LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{RSM}$	non-repetitive peak reverse voltage BYD43U	$T_{amb} = 25^{\circ}\text{C}$ ; lead length = 10 mm; see Figs 2 and 3; averaged over any 20 ms period; see also Figs 10 and 11	—	1300	V
	BYD43V		—	1500	V
	BYD43-16		—	1700	V
	BYD43-18		—	1900	V
	BYD43-20		—	2100	V
$V_{RRM}$	repetitive peak reverse voltage BYD43U	$T_{amb} = 25^{\circ}\text{C}$ ; lead length = 10 mm; see Figs 2 and 3; averaged over any 20 ms period; see also Figs 10 and 11	—	1200	V
	BYD43V		—	1400	V
	BYD43-16		—	1600	V
	BYD43-18		—	1800	V
	BYD43-20		—	2000	V
$I_{F(AV)}$	average forward current BYD43U and V	$T_{tp} = 55^{\circ}\text{C}$ ; lead length = 10 mm; see Figs 2 and 3; averaged over any 20 ms period; see also Figs 10 and 11	—	1.20	A
	BYD43-16 to 20		—	0.68	A
$I_{F(AV)}$	average forward current BYD43U and V	$T_{amb} = 65^{\circ}\text{C}$ ; PCB mounting (see Fig.20); see Figs 4 and 5; averaged over any 20 ms period; see also Figs 10 and 11	—	0.65	A
	BYD43-16 to 20		—	0.30	A
$I_{FRM}$	repetitive peak forward current BYD43U and V	$T_{tp} = 55^{\circ}\text{C}$ ; see Figs 6 and 7	—	11	A
	BYD43-16 to 20		—	6	A
$I_{FRM}$	repetitive peak forward current BYD43U and V	$T_{amb} = 65^{\circ}\text{C}$ ; see Figs 8 and 9	—	6.0	A
	BYD43-16 to 20		—	3.2	A

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SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$I_{F\text{SM}}$	non-repetitive peak forward current BYD43U and V BYD43-16 to 20	$t = 10 \text{ ms}$ half sinewave; $T_j = T_{j\text{max}}$ prior to surge; $V_R = V_{RRM\text{max}}$	–	6	A
$T_{\text{stg}}$	storage temperature		-65	+175	°C
$T_j$	junction temperature	see Figs 12 and 13	-65	+175	°C

## ELECTRICAL CHARACTERISTICS

 $T_j = 25 \text{ }^\circ\text{C}$  unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_F$	forward voltage BYD43U and V BYD43-16 to 20	$I_F = 1 \text{ A}; T_j = T_{j\text{max}}$ see Figs 14 and 15	–	–	1.20	V
$V_F$	forward voltage BYD43U and V BYD43-16 to 20	$I_F = 1 \text{ A};$ see Figs 14 and 15	–	–	2.05	V
$I_R$	reverse current BYD43U and V BYD43-16 to 20	$V_R = V_{RRM\text{max}}$ see Figs 16 and 17	–	–	1	$\mu\text{A}$
$I_R$	reverse current BYD43U and V BYD43-16 to 20	$V_R = V_{RRM\text{max}}$ $T_j = 165 \text{ }^\circ\text{C}$ ; see Fig 16	–	–	5	$\mu\text{A}$
$I_R$	reverse current BYD43U and V BYD43-16 to 20	$V_R = V_{RRM\text{max}}$ $T_j = 125 \text{ }^\circ\text{C}$ ; see Fig 17	–	–	100	$\mu\text{A}$
$t_{rr}$	reverse recovery time BYD43U and V BYD43-16 to 20	when switched from $I_F = 0.5 \text{ A}$ to $I_R = 1 \text{ A}$ ; measured at $I_R = 0.25 \text{ A}$ ; see Fig 22	–	–	250	ns
$C_d$	diode capacitance BYD43U and V BYD43-16 to 20	$f = 1 \text{ MHz}; V_R = 0 \text{ V}$ ; see Figs 18 and 19	–	20	–	pF
$\left  \frac{dI_R}{dt} \right $	maximum slope of reverse recovery current BYD43U and V BYD43-16 to 20	when switched from $I_F = 1 \text{ A}$ to $V_R \geq 30 \text{ V}$ and $dI_F/dt = -1 \text{ A}/\mu\text{s}$ ; see Fig.21	–	–	5	$\text{A}/\mu\text{s}$
			–	–	5	$\text{A}/\mu\text{s}$

## THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{\text{th,j-tp}}$	thermal resistance from junction to tie-point	lead length = 10 mm	60	K/W
$R_{\text{th,j-a}}$	thermal resistance from junction to ambient	note 1	120	K/W

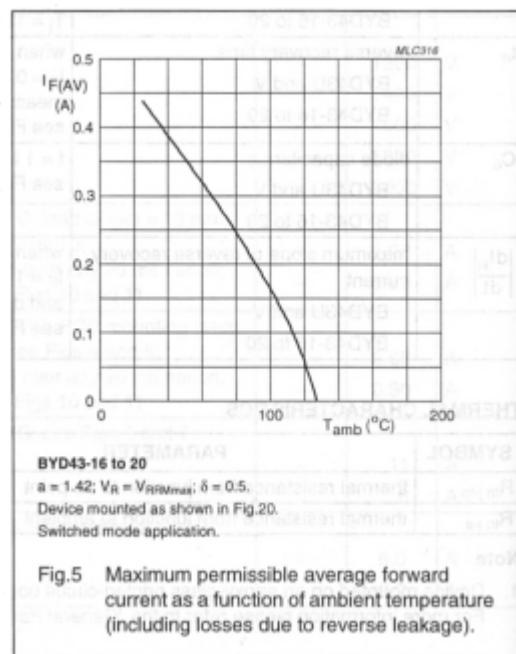
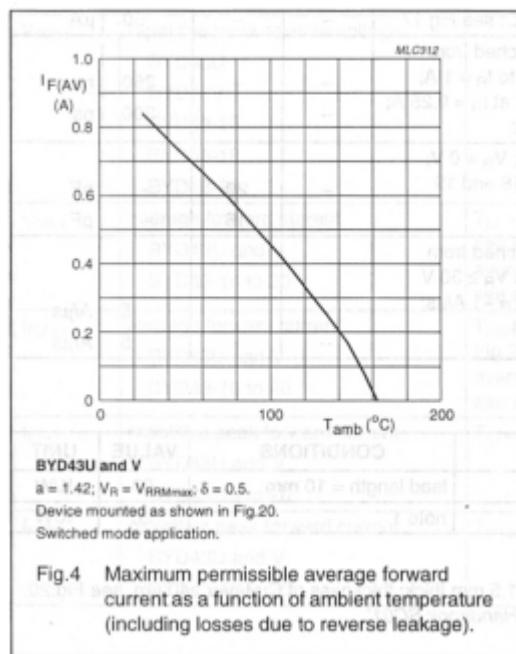
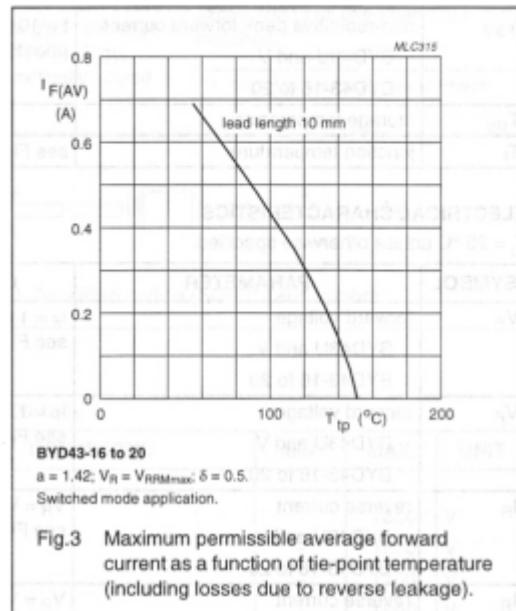
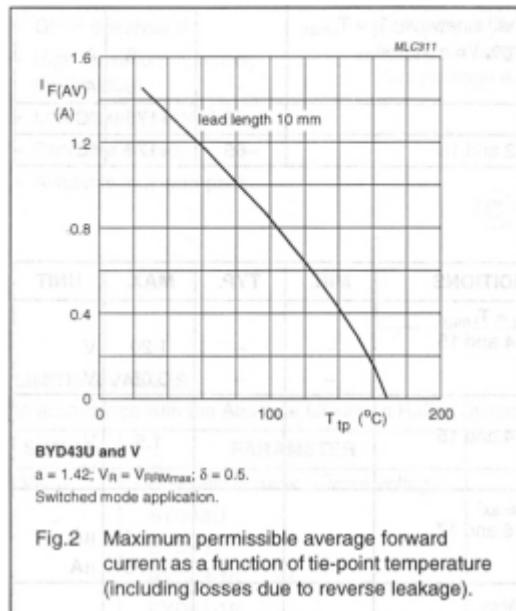
## Note

- Device mounted on an epoxy-glass printed-circuit board, 1.5 mm thick; thickness of Cu-layer  $\geq 40 \mu\text{m}$ , see Fig.20.  
For more information please refer to the 'General Part of Handbook SC01'.

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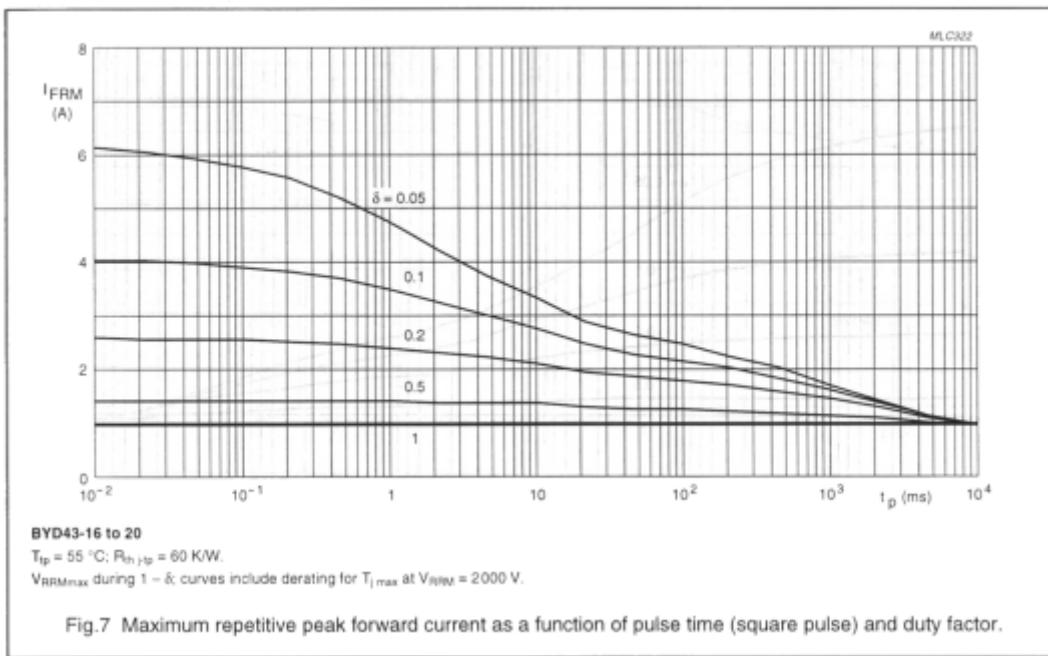
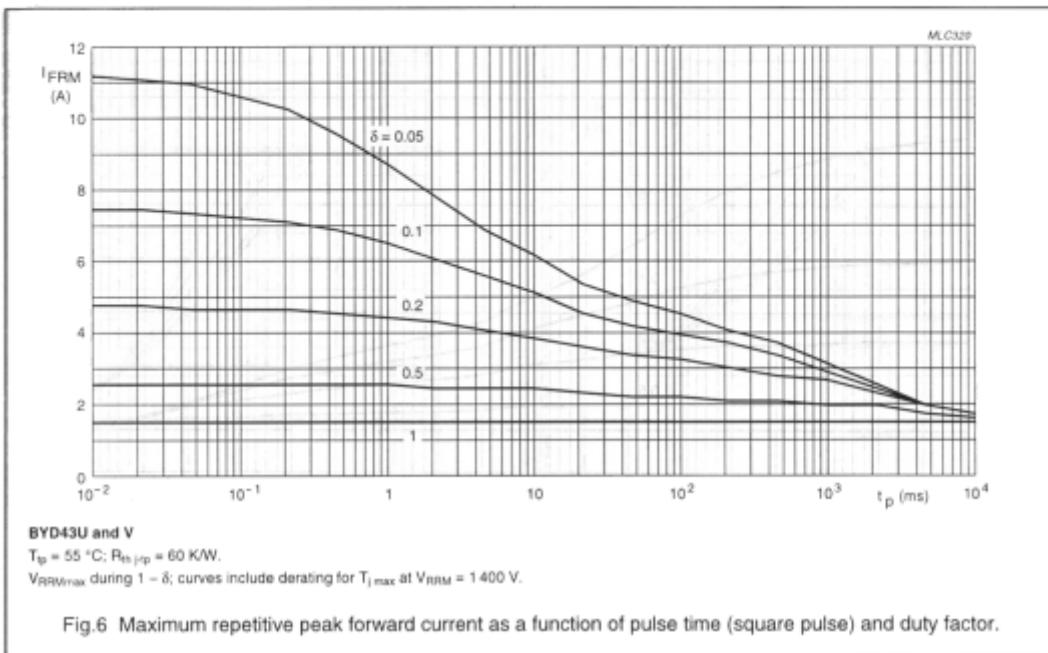
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## GRAPHICAL DATA



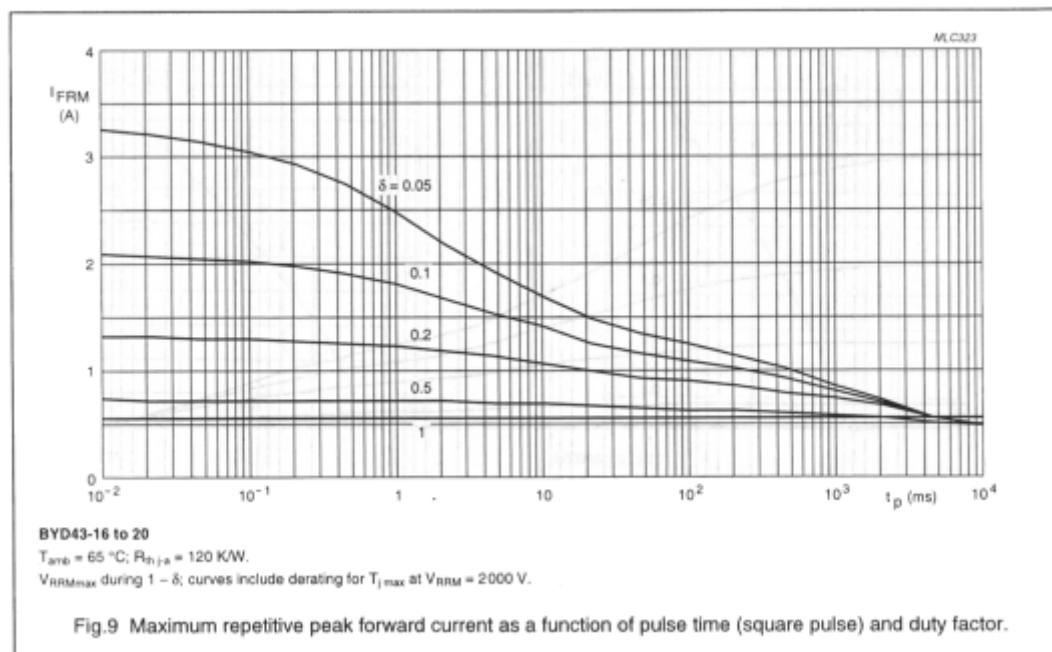
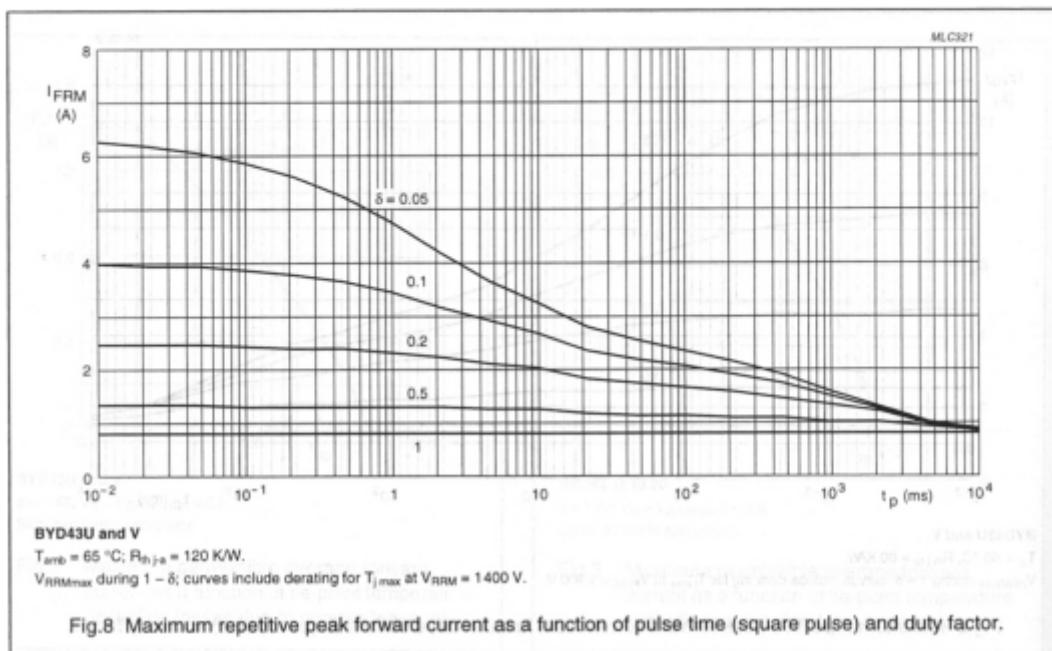
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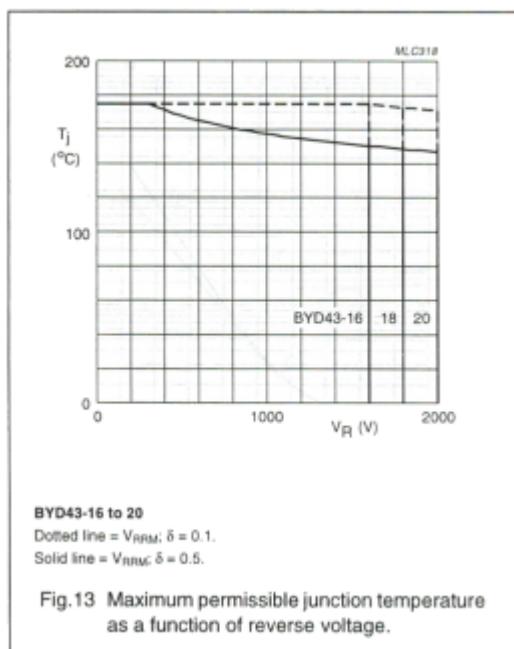
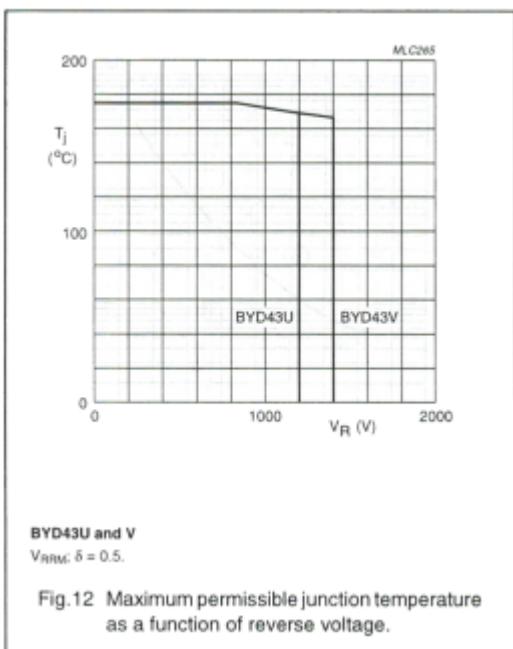
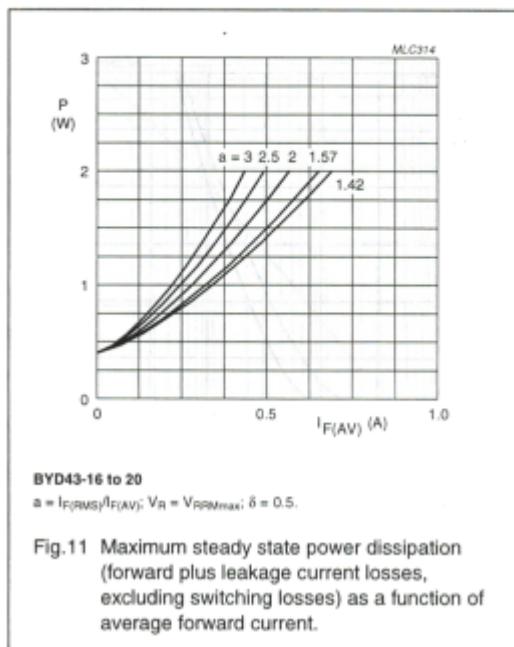
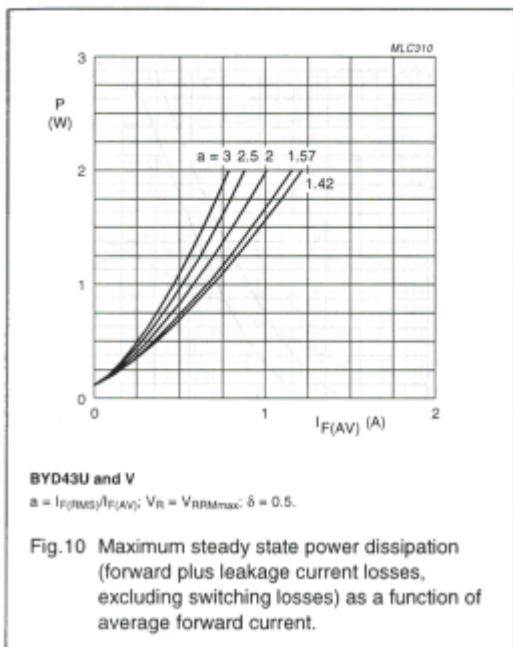
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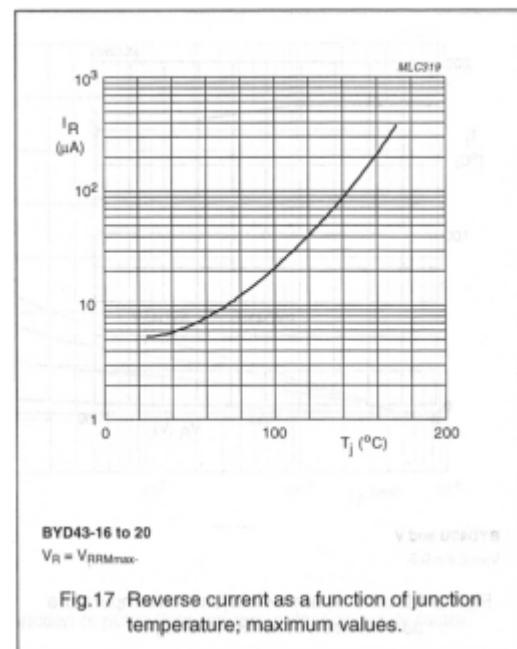
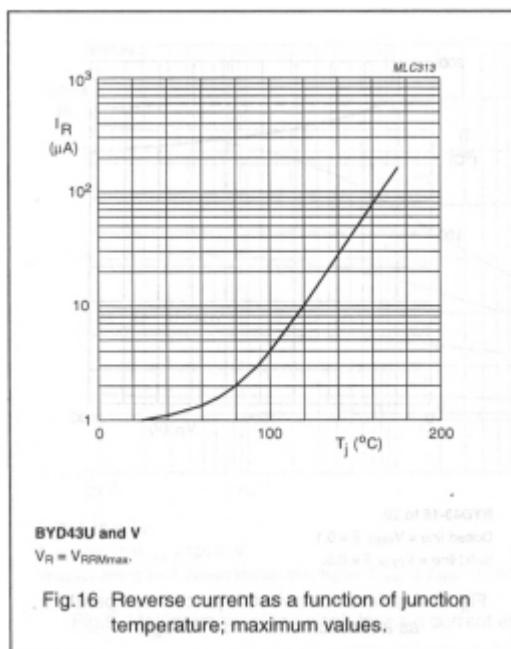
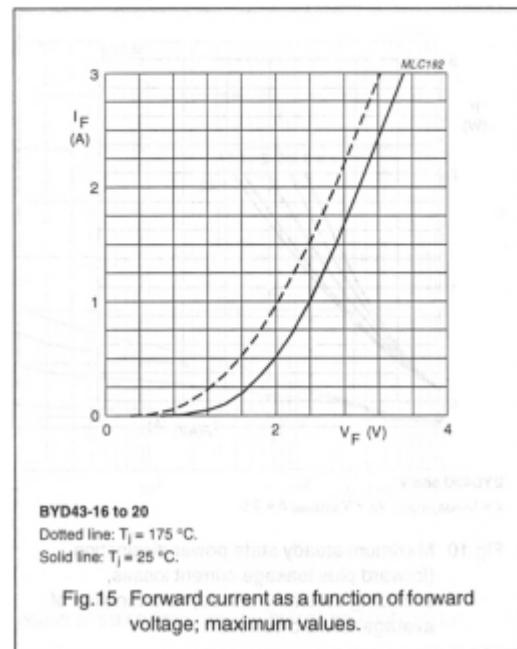
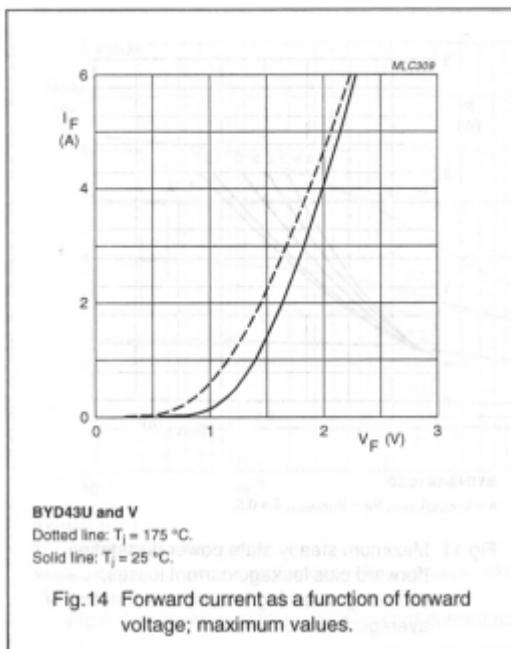
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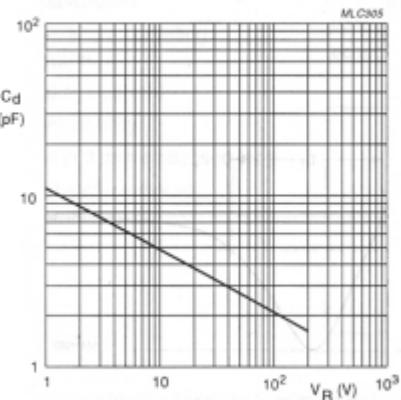
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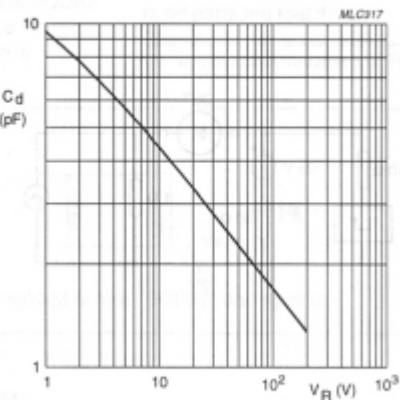
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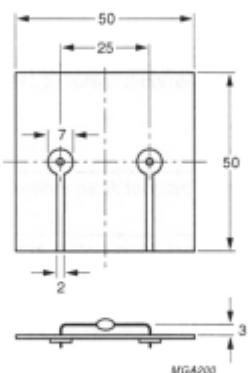
BYD43U and V  
 $f = 1 \text{ MHz}$ ;  $T_j = 25^\circ\text{C}$ .

Fig.18 Diode capacitance as a function of reverse voltage; typical values.



BYD43-16 to 20  
 $f = 1 \text{ MHz}$ ;  $T_j = 25^\circ\text{C}$ .

Fig.19 Diode capacitance as a function of reverse voltage; typical values.



Dimensions in mm.

Fig.20 Device mounted on a printed-circuit board.

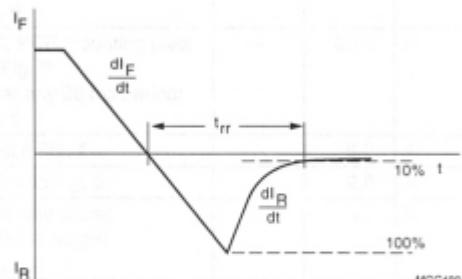


Fig.21 Reverse recovery definitions.

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